



Final Product Change Notification

201603015F01

Issue Date: 18-Mar-2016

Effective Date: 30-Jun-2016

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Management Summary

- The product data sheet is incorrect
- Correct the product data sheets for standard and automotive type 74LVC1G3157 in all packages

Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Process	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Equipment	<input checked="" type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Location	<input type="checkbox"/> Electrical spec./Test coverage

Correction of product data sheet 74LVC1G3157

Details of this Change

Correction of product data sheet 74LVC1G3157

Product data sheet 74LVC1G3157 update to address errata:

- Corrected enable and disable times
- Conditions and test circuit for -3 dB frequency response
- Test circuit for charge injection

The product data sheets have been updated see details in revision history paragraph

Why do we Implement this Change

The product data sheet is updated to align with product performance

Identification of Affected Products

Not applicable, product identification does not change

Product Availability

Sample Information

Samples are available from 18-Mar-2016

Not applicable, no changes in the product itself, this is only a product data sheet update

Production

Planned first shipment 30-Jun-2016

Impact

No impact on product performance (product data sheet errata)

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Not applicable, no changes in the product itself, this is only a product data sheet update

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 17-Apr-2016.

Remarks

- No changes in the product itself, this is only a product data sheet update
- Updated product data sheet attached and will posted on internet at effective PCN implementation date

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Emile Busink
Position PCN specialist - QA engineering Logic Products
e-mail address emile.busink@nxp.com

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